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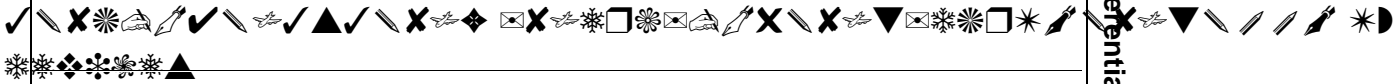


August 2001
Revised December 2001

FIN1032

3.3V LVDS 4-Bit High Speed Differential Receiver
The receiver translates LVDS differential input threshold of 100mV, to LVTTL signal level. Greater than 40

- 3.3V power supply operation
- 0.4ns maximum differential pulse skew
- 2.5ns maximum propagation delay
- Low power dissipation
- Power OFF protection



Ordering Code:

- 16-Lead SOIC and TSSOP packages save space

FIN1032 3.3V LVDS 4-Bit High Speed Differential Receiver

Absolute Maximum Ratings(Note 1)

Supply Voltage (V_{CC})	-0.5V to +4.6 V
DC Input Voltage (V_{IN})	-0.5V to +4.6 V
DC Input Voltage (V_{OUT})	-0.5V to 6 V
DC Output Current (I_O)	16 mA
Storage Temperature Range (T_{STG})	-65°C to +150°C
Max Junction Temperature (T_J)	150°C
Lead Temperature (T_L) (Soldering, 10 seconds)	260°C
ESD (Human Body Model)	≥ 10,000 V
ESD (Machine Model)	≥ 500 V

Recommended Operating Conditions

Supply Voltage (V_{CC})	3.0 V to 3.6 V
Magnitude of Differential Voltage ($ V_{ID} $)	100 mV to V_{CC}
Common-Mode Input Voltage (V_{IC})	0.05 V to 2.35V
Input Voltage (V_{IN})	0 to V_{CC}
Operating Temperature (T_A)	-40°C to +85°C

Note 1: The "Absolute Maximum Ratings" are those values beyond which damage to the device may occur. The databook specifications should be met, without exception, to ensure that the system design is reliable over its power supply, temperature and output/input loading variables. Fairchild does not recommend operation of circuits outside databook specification.

DC Electrical Characteristics

Over supply voltage and operating temperature ranges, unless otherwise specified

Symbol	Parameter	Test Conditions	Min	Typ (Note 2)	Max	Units
V_{TH}	Differential Input Threshold HIGH	See Figure 1 and Table 1			100	mV
V_{TL}	Differential Input Threshold LOW	See Figure 1 and Table 1	-100			mV
I_{IN}	Input Current	$V_{IN} = 0V$ or V_{CC}			±20	μA
$I_{I(OFF)}$	Power-OFF Input Current	$V_{CC} = 0V$, $V_{IN} = 0V$ or 3.6V			±20	μA
V_{IH}	Input High Voltage (EN or \overline{EN})		2.0		V_{CC}	V
V_{IL}	Input Low Voltage (EN or \overline{EN})		GND		0.8	V
V_{OH}	Output HIGH Voltage	$I_{OH} = -100 \mu A$ $I_{OH} = -8 mA$	$V_{CC} - 0.2$ 2.4			V
V_{OL}	Output LOW Voltage	$I_{OH} = 100 \mu A$ $I_{OL} = 8 mA$			0.2 0.5	V
V_{IK}	Input Clamp Voltage	$I_{IK} = -18 mA$	-1.5			V
I_{OZ}	Disabled Output Leakage Current	EN = 0.8 and $\overline{EN} = 2V$, $V_{OUT} = 3.6V$ or 0V			±20	μA
I_{OS}	Output Short Circuit Test	Receiver Enabled, $V_{OUT} = 0V$ (one output shorted at a time)	-15		-100	mA
I_{CCZ}	Disabled Power Supply Current	Receiver Disabled			5	mA
I_{CC}	Power Supply Current	Receiver Enabled, ($R_{IN+} = 1V$ and $R_{IN-} = 1.4V$) or ($R_{IN+} = 1.4V$ and $R_{IN-} = 1V$)			15	mA
$I_{PU/PD}$	Output Power Up/Power Down	$V_{CC} = 0V$ to 1.5V			±20	μA

Note 2: All typical values are at $T_A = 25^\circ C$ and with $V_{CC} = 3.3V$.

AC Electrical Characteristics

Over supply voltage and operating temperature ranges, unless otherwise specified

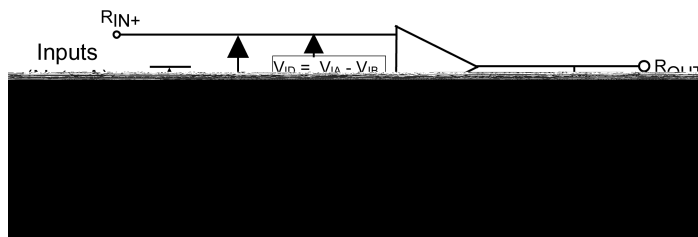
Symbol	Parameter	Test Conditions	Min	Typ (Note 3)	Max	Units	
t_{PLH}	Propagation Delay LOW-to-HIGH	$ V_{ID} = 400 \text{ mV}$, $C_L = 10 \text{ pF}$, $R_L = 1 \text{ k}\Omega$ See Figure 1 and Figure 2	1.0		2.5	ns	
t_{PHL}	Propagation Delay HIGH-to-LOW		1.0		2.5	ns	
t_{TLH}	Output Rise Time (20% to 80%)		0.7	1.2	ns		
t_{THL}	Output Fall Time (80% to 20%)		0.7	1.2	ns		
$t_{SK(P)}$	Pulse Skew $ t_{PLH} - t_{PHL} $				0.4	ns	
$t_{SK(LH)}$	Channel-to-Channel Skew (Note 4)				0.3	ns	
$t_{SK(HL)}$							
$t_{SK(PP)}$	Part-to-Part Skew (Note 5)				1.0	ns	
f_{MAX}	Maximum Operating Frequency (Note 6)		$R_L = 1 \text{ k}\Omega$, $C_L = 10 \text{ pF}$, see Figure 1 and Figure 2	200	325		MHz
t_{ZH}	LVTTL Output Enable Time from Z to HIGH		$R_L = 1 \text{ k}\Omega$, $C_L = 10 \text{ pF}$, See Figure 3 and Figure 4			5.0	ns
t_{ZL}	LVTTL Output Enable Time from Z to LOW				5.0	ns	
t_{HZ}	LVTTL Output Disable Time from HIGH to Z				5.0	ns	
t_{LZ}	LVTTL Output Disable Time from LOW to Z				5.0	ns	

Note 3: All typical values are at $T_A = 25^\circ\text{C}$ and with $V_{CC} = 3.3\text{V}$.

Note 4: $t_{SK(LH)}$, $t_{SK(HL)}$ is the skew between specified outputs of a single device when the outputs have identical loads and are switching in the same direction.

Note 5: $t_{SK(PP)}$ is the magnitude of the difference in propagation delay times between any specified terminals of two devices switching in the same direction (either LOW-to-HIGH or HIGH-to-LOW) when both devices operate with the same supply voltage, same temperature, and have identical test circuits.

Note 6: f_{MAX} Criteria: Input $t_R = t_F < 1 \text{ ns}$, $V_{ID} = 300 \text{ mV}$, (1.05V to 1.35V pp), 50% duty cycle; Output duty cycle 40% to 60%, $V_{OL} < 0.5\text{V}$, $V_{OH} > 2.4\text{V}$. All channels switching in phase.



Note A: All input pulses have frequency = 10MHz, t_R or $t_F = 1 \text{ ns}$

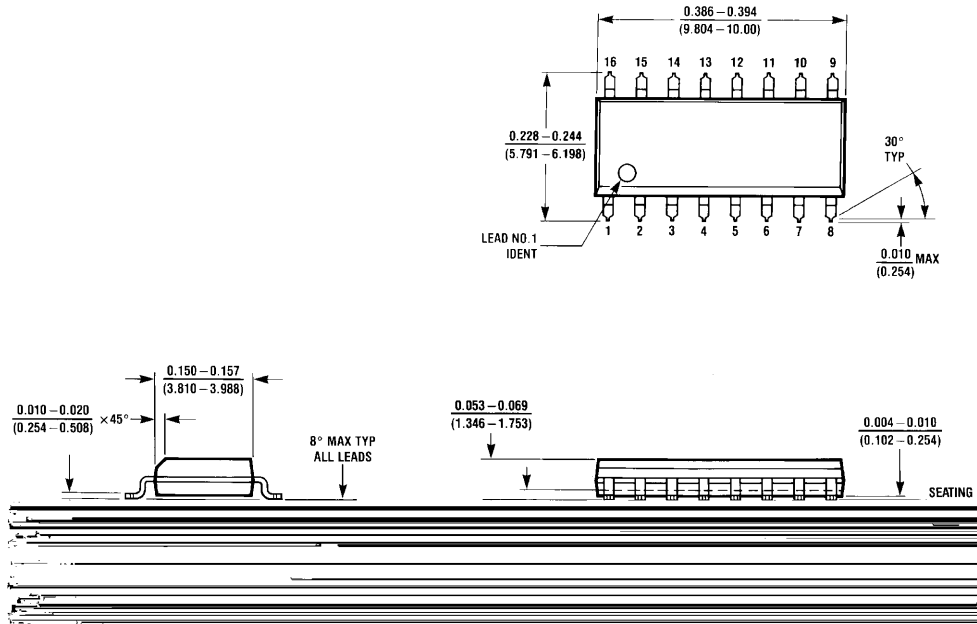
Note B: C_L includes all probe and jig capacitances

FIGURE 1. Differential Receiver Voltage Definitions and Propagation Delay and Transition Time Test Circuit

TABLE 1. Receiver Minimum and Maximum Input Threshold Test Voltages

Applied Voltages (V)		Resulting Differential Input Voltage (mV)	Resulting Common Mode Input Voltage (V)
V_{IA}	V_{IB}	V_{ID}	V_{IC}
1.25	1.15	100	1.2
1.15	1.25	-100	1.2
2.4	2.3	100	2.35
2.3	2.4	-100	2.35
0.1	0	100	0.05
0	0.1	-100	0.05
1.5	0.9	600	1.2
0.9	1.5	-600	1.2
2.4	1.8	600	2.1
1.8	2.4	-600	2.1
0.6	0	600	0.3
0	0.6	-600	0.3

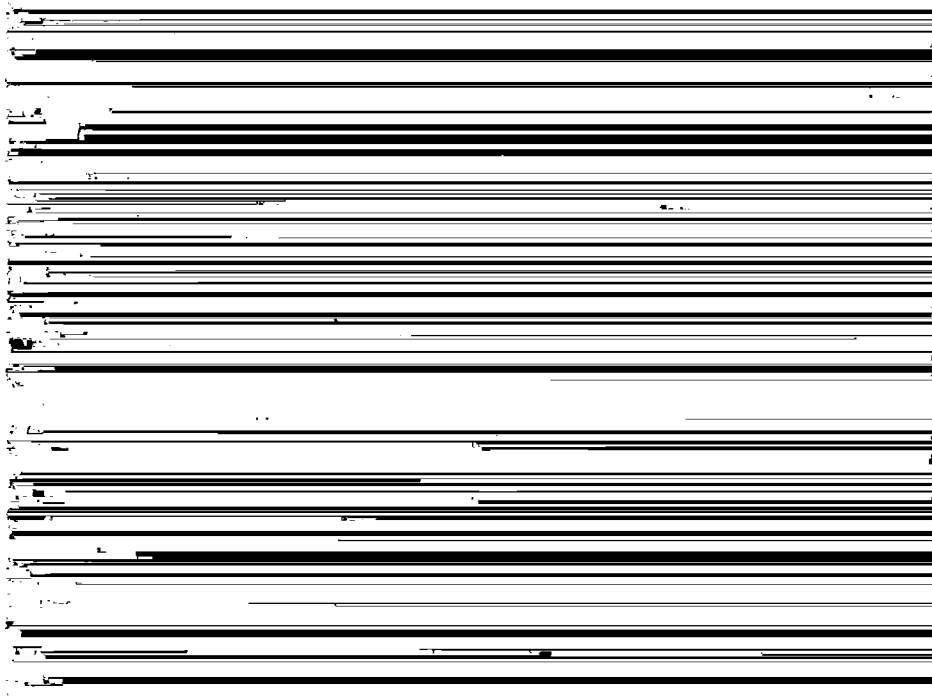
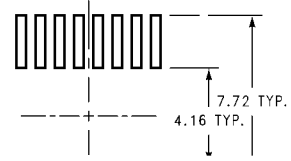
Physical Dimensions inches (millimeters) unless otherwise noted



**16-Lead Small Outline Integrated Circuit (SOIC), JEDEC MS-012, 0.150" Narrow
Package Number M16A**

Physical Dimensions inches (millimeters) unless otherwise noted (Continued)

DIMENSIONS_MILLIMETERS ONLY



16-Lead Thin Shrink Small Outline Package (TSSOP), JEDEC MO-153, 4.4mm Wide
Package Number MTC16

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